Product data sheet

# 1. Product profile

### 1.1 General description

The BB170 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD323 (SC-76) very small SMD plastic package.

### 1.2 Features and benefits

- Excellent linearity
- Very small SMD plastic package
- $C_{d(28V)} = 2.6 \text{ pF}$ ;  $C_{d(1V)}$  to  $C_{d(28V)}$  ratio = 15
- Low series resistance

### 1.3 Applications

■ Voltage Controlled Oscillators (VCO)

# 2. Pinning information

Table 1. Pinning

Pin	Description	Simplified outline	Symbol
1	cathode	[1]	ш
2	anode	1 2	sym008

<sup>[1]</sup> The marking bar indicates the cathode.

# 3. Ordering information

Table 2. Ordering information

Type number	Package			
	Name	Description	Version	
BB170	SC-76	plastic surface-mounted package; 2 leads	SOD323	



### VHF variable capacitance diode

# 4. Marking

Table 3. Marking

Type number	Marking code
BB170	4H

# 5. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_R$	reverse voltage		-	30	V
I <sub>F</sub>	forward current		-	20	mA
T <sub>stg</sub>	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

## 6. Characteristics

Table 5. Characteristics

 $T_i = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$I_R$	reverse current	$V_R = 30 \text{ V}$	[1]	-	-	10	nΑ
		$V_R = 30 \text{ V}; T_j = 85 ^{\circ}\text{C}$	[1]	-	-	200	nΑ
r <sub>s</sub>	diode series resistance	$f = 100 \text{ MHz}; C_d = 12 \text{ pF}$		-	-	0.9	Ω
C <sub>d</sub>	diode capacitance	f = 1 MHz	[2]				
		V <sub>R</sub> = 1 V		36.8	-	41.8	pF
		V <sub>R</sub> = 28 V		2.4	2.6	2.75	pF
C <sub>d(1V)</sub> /C <sub>d(28V)</sub>	diode capacitance ratio (1 V to 28 V)	f = 1 MHz		14.5	15	-	

<sup>[1]</sup> See Figure 2.

<sup>[2]</sup> See Figure 1 and Figure 3.

### VHF variable capacitance diode

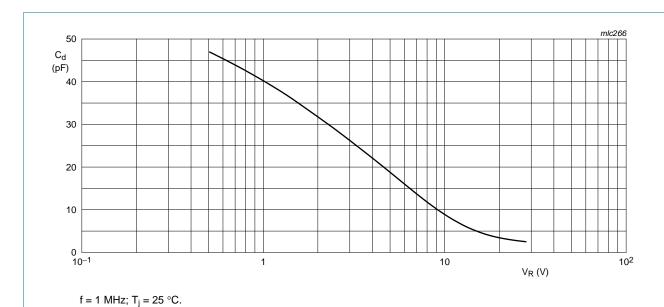


Fig 1. Diode capacitance as a function of reverse voltage; typical values.

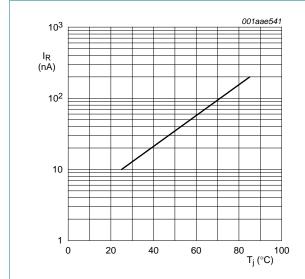
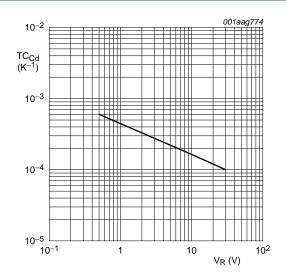


Fig 2. Reverse current as a function of junction temperature; maximum values.



 $T_i = 0$  °C to 85 °C.

Fig 3. Diode capacitance temperature coefficient as a function of reverse voltage; typical values.

### VHF variable capacitance diode

# 7. Package outline

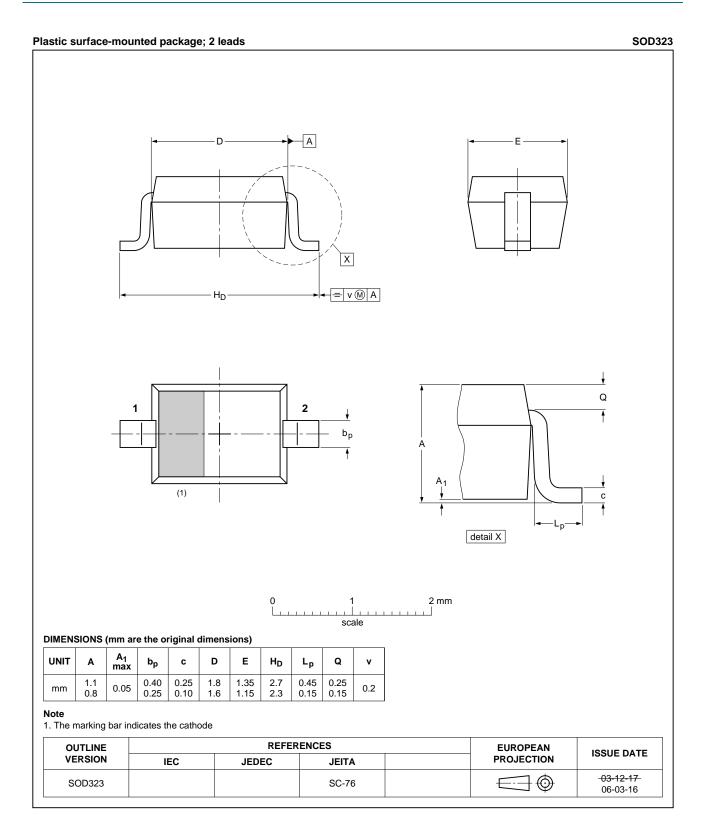


Fig 4. Package outline SOD323 (SC-76)

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### VHF variable capacitance diode

# 8. Abbreviations

Table 6. Abbreviations

Acronym	Description
SMD	Surface Mounted Device
VHF	Very High Frequency

# 9. Revision history

#### Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB170 v.1	20130325	Product data sheet	-	-

#### VHF variable capacitance diode

## 10. Legal information

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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#### VHF variable capacitance diode

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